



COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

Product Summary

| Device | V _{(BR)DSS} | R _{DS(ON)} Max | I _D Max T _A = +25°C |
|-----------------|----------------------|---------------------------------|--|
| | | $29m\Omega @ V_{GS} = 4.5V$ | 5.6A |
| Q1 N-Channel | 12V | $34m\Omega$ @ $V_{GS} = 2.5V$ | 5.1A |
| | | $44m\Omega$ @ $V_{GS} = 1.8V$ | 4.5A |
| | | $65m\Omega @ V_{GS} = 1.5V$ | 3.7A |
| | | $61m\Omega @ V_{GS} = -4.5V$ | -3.8A |
| Q2 P-Channel | -12V | $81m\Omega @ V_{GS} = -2.5V$ | -3.3A |
| | | 115mΩ @ V _{GS} = -1.8V | -2.8A |
| | | 170mΩ @ V _{GS} = -1.5V | -2.3A |

Description

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}), yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

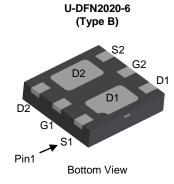
- Loadswitch
- Power Management Functions
- Portable Power Adaptors

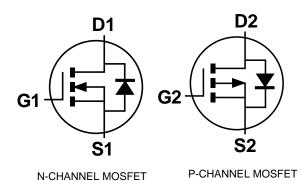
Features

- Low On-Resistance
- Low Input Capacitance
- Low Profile, 0.6mm Max Height
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: U-DFN2020-6 (Type B)
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Terminals Connections: See Diagram Below
- Weight: 0.0065 grams (Approximate)





Internal Schematic

Ordering Information (Note 4)

| Part Number | Case | Packaging |
|-----------------|--------------------|--------------------|
| DMC1229UFDB -7 | U-DFN2020-6 Type B | 3,000/Tape & Reel |
| DMC1229UFDB -13 | U-DFN2020-6 Type B | 10,000/Tape & Reel |

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.



Marking Information



D2 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: A = 2013) M = Month (ex: 9 = September)

Date Code Key

| Year | 201 | 2 | 2013 | | 2014 | 20 | 15 | 2016 | | 2017 | 2 | 2018 |
|-------|-----|-----|------|-----|------|-----|-----|------|-----|------|-----|------|
| Code | Z | | Α | | В | (| 2 | D | | Е | | F |
| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
| Code | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 0 | N | D |

Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

| Characteristic | Symbol | Q1 N-Channel | Q2 P-Channel | Units | | |
|--|--|----------------------------------|-----------------|------------|--------------|---|
| Drain-Source Voltage | Drain-Source Voltage | | | | | V |
| Gate-Source Voltage | V_{GSS} | ±8 | ±8 | V | | |
| | Steady State | $T_A = +25$ °C $T_A = +70$ °C | I _D | 5.6 4.4 | -3.8 -3.0 | А |
| Continuous Drain Current (Note 5) V _{GS} = 4.5V | t<5s | $T_A = +25$ °C $T_A = +70$ °C | I _D | 7.2 5.8 | -5.0 -4.0 | А |
| Maximum Continuous Body Diode Forward Curre | Is | 1 | -1 | Α | | |
| Pulsed Drain Current (10µs Pulse, Duty Cycle = | Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%) | | | | -15 | Α |

Thermal Characteristics

| Characteristic | | Symbol | Value | Units | |
|--|----------------|-----------------|-------------|-------|--|
| Total Power Dissipation (Note 5) | Steady State | 0 | 1.4 | W | |
| Total Power Dissipation (Note 5) | t<5s | P_{D} | 2.2 | VV | |
| Thermal Resistance, Junction to Ambient (Note 5) | Steady State | D | 92 | | |
| Thermal Resistance, Junction to Ambient (Note 5) | t<5s | $R_{	heta JA}$ | 55 | °C/W | |
| Thermal Resistance, Junction to Case (Note 5) | $R_{	heta JC}$ | 30 | | | |
| Operating and Storage Temperature Range | | $T_{J,}T_{STG}$ | -55 to +150 | °C | |

Note: 5. Device mounted on 1" x 1" FR-4 PCB with high coverage 2oz. copper, single sided.



Electrical Characteristics Q1 N-Channel (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition | | |
|--|---------------------|-----|------|------|-------|--|--|--|
| OFF CHARACTERISTICS (Note 6) | | | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | 12 | _ | _ | V | $V_{GS} = 0V, I_D = 250\mu A$ | | |
| Zero Gate Voltage Drain Current T _J = +25°C | I _{DSS} | l | _ | 1.0 | μΑ | $V_{DS} = 12V$, $V_{GS} = 0V$ | | |
| Gate-Source Leakage | I _{GSS} | _ | _ | ±100 | nA | $V_{GS} = \pm 8V$, $V_{DS} = 0V$ | | |
| ON CHARACTERISTICS (Note 6) | | | | | | | | |
| Gate Threshold Voltage | V _{GS(th)} | 0.4 | | 1 | ٧ | $V_{DS} = V_{GS}$, $I_D = 250\mu A$ | | |
| | | | 17 | 29 | | $V_{GS} = 4.5V, I_D = 5A$ | | |
| Static Drain-Source On-Resistance | D | | 20 | 34 | mΩ | $V_{GS} = 2.5V, I_D = 4.6A$ | | |
| Static Dialif-Source Off-Nesistance | R _{DS(ON)} | _ | 24 | 44 | 11122 | $V_{GS} = 1.8V, I_D = 4.1A$ | | |
| | | - | 30 | 65 | | $V_{GS} = 1.5V, I_D = 2A$ | | |
| Forward Transfer Admittance | Y _{fs} | _ | 6.5 | _ | S | $V_{DS} = 10V, I_{D} = 5A$ | | |
| Diode Forward Voltage | V _{SD} | _ | 0.6 | 1.2 | V | $V_{GS} = 0V, I_{S} = 1A$ | | |
| DYNAMIC CHARACTERISTICS (Note 7) | | | | | | | | |
| Input Capacitance | C _{iss} | 1 | 914 | _ | рF | \\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ | | |
| Output Capacitance | Coss | - | 132 | _ | pF | $V_{DS} = 6V, V_{GS} = 0V,$ f = 1.0MHz | | |
| Reverse Transfer Capacitance | C_{rss} | _ | 119 | _ | pF | 1 - 1.000112 | | |
| Gate Resistance | R_g | _ | 1.26 | _ | Ω | $V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$ | | |
| Total Gate Charge (V _{GS} = 4.5V) | | _ | 10.5 | _ | nC | | | |
| Total Gate Charge (V _{GS} = 8V) | Q_g | _ | 19.6 | _ | nC | 0.4 | | |
| Gate-Source Charge | Q _{gs} | _ | 1.2 | _ | nC | $V_{DS} = 6V, I_{D} = 6.5A$ | | |
| Gate-Drain Charge | Q _{qd} | _ | 1.6 | _ | nC | | | |
| Turn-On Delay Time | t _{D(on)} | _ | 5.0 | _ | nS | | | |
| Turn-On Rise Time | t _r | _ | 10.5 | _ | nS | $V_{DD} = 6V, V_{GS} = 4.5V,$ | | |
| Turn-Off Delay Time | t _{D(off)} | _ | 16.6 | _ | nS | $R_L = 1.2\Omega$, $R_G = 1\Omega$ | | |
| Turn-Off Fall Time | t _f | _ | 4.1 | _ | nS | | | |

Electrical Characteristics Q2 P-Channel (@T_A = +25°C, unless otherwise specified.)

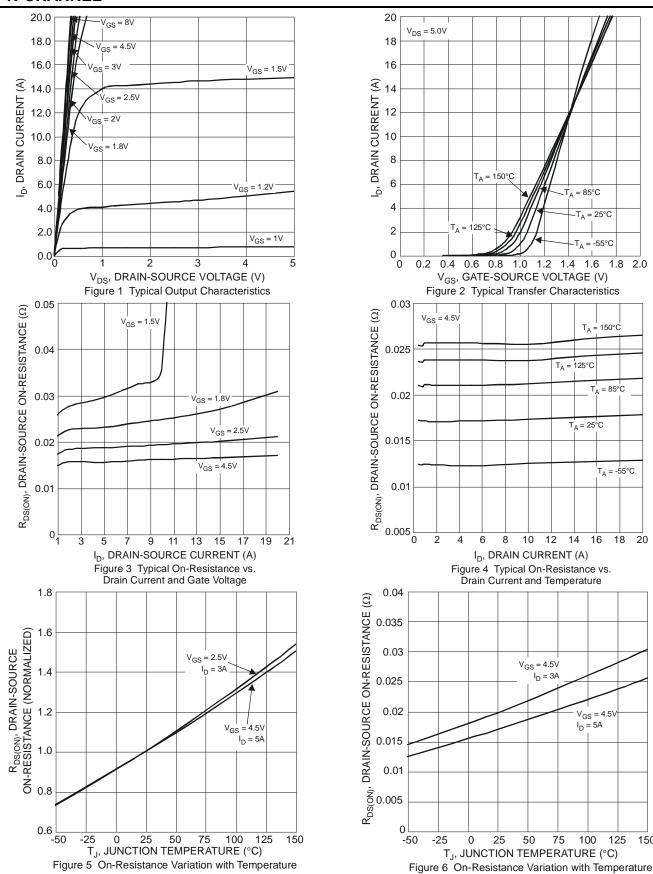
| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition | | |
|--|---------------------|------|-------|------|-------|---|--|--|
| OFF CHARACTERISTICS (Note 6) | | | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | -12 | _ | _ | V | $V_{GS} = 0V, I_D = -250\mu A$ | | |
| Zero Gate Voltage Drain Current T _J = +25°C | I _{DSS} | _ | _ | -1.0 | μΑ | $V_{DS} = -12V, V_{GS} = 0V$ | | |
| Gate-Source Leakage | IGSS | - | _ | ±100 | nA | $V_{GS} = \pm 8V$, $V_{DS} = 0V$ | | |
| ON CHARACTERISTICS (Note 6) | | | | | | | | |
| Gate Threshold Voltage | V _{GS(th)} | -0.4 | _ | -1 | V | $V_{DS} = V_{GS}$, $I_D = -250\mu A$ | | |
| | | _ | 37 | 61 | | $V_{GS} = -4.5V$, $I_D = -3.6A$ | | |
| Static Drain-Source On-Resistance | D | - | 47 | 81 | mΩ | $V_{GS} = -2.5V$, $I_D = -3.2A$ | | |
| Static Dialif-Source Off-Resistance | R _{DS(ON)} | l | 63 | 115 | 11122 | $V_{GS} = -1.8V, I_{D} = -1A$ | | |
| | | - | 90 | 170 | | $V_{GS} = -1.5V, I_D = -1A$ | | |
| Forward Transfer Admittance | Y _{fs} | _ | 5.5 | _ | S | $V_{DS} = -10V, I_{D} = -3.6A$ | | |
| Diode Forward Voltage | V_{SD} | _ | -0.65 | -1.2 | V | $V_{GS} = 0V, I_{S} = -1A$ | | |
| DYNAMIC CHARACTERISTICS (Note 7) | | | • | • | | | | |
| Input Capacitance | C _{iss} | - | 915 | _ | pF | ., ., ., ., | | |
| Output Capacitance | Coss | l | 225 | _ | рF | $V_{DS} = -6V, V_{GS} = 0V,$ -f = 1.0MHz | | |
| Reverse Transfer Capacitance | C _{rss} | _ | 183 | _ | pF | 1 – 1.000112 | | |
| Gate Resistance | Rg | _ | 56.9 | _ | Ω | $V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$ | | |
| Total Gate Charge (V _{GS} = -4.5V) | | _ | 10.7 | _ | nC | | | |
| Total Gate Charge (V _{GS} = -8V) | Q_g | _ | 17.9 | _ | nC | ., | | |
| Gate-Source Charge | Qgs | _ | 1.7 | _ | nC | $V_{DS} = -6V, I_{D} = -4.3A$ | | |
| Gate-Drain Charge | Q _{gd} | _ | 3.0 | _ | nC | | | |
| Turn-On Delay Time | t _{D(on)} | _ | 5.7 | _ | nS | | | |
| Turn-On Rise Time | t _r | _ | 11.5 | _ | nS | $V_{DD} = -6V, V_{GS} = -4.5V,$ | | |
| Turn-Off Delay Time | t _{D(off)} | _ | 27.8 | _ | nS | $R_L = 1.6\Omega$, $R_G = 1\Omega$ | | |
| Turn-Off Fall Time | t _f | _ | 26.4 | _ | nS | | | |

Notes: 6. Short duration pulse test used to minimize self-heating effect.

^{7.} Guaranteed by design. Not subject to product testing.



Q1 N-CHANNEL



20



Q1 N-CHANNEL (Continued)

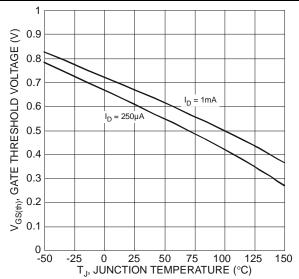
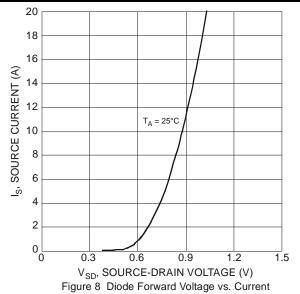
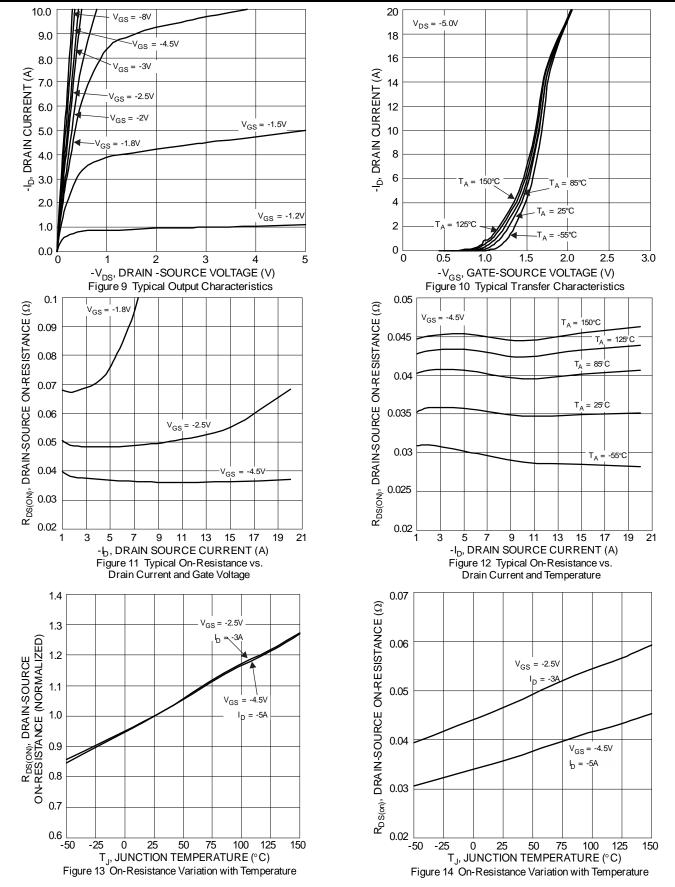


Figure 7 Gate Threshold Variation vs. Ambient Temperature



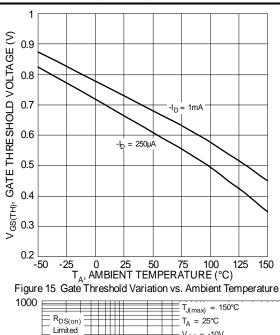


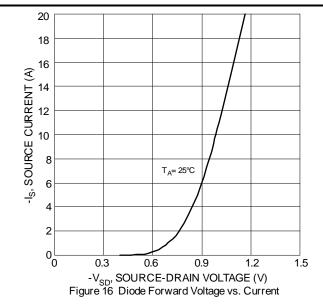
Q2 P-CHANNEL

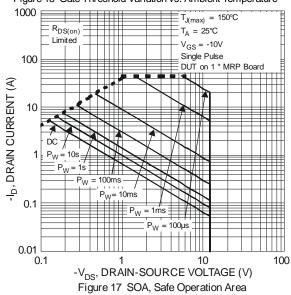


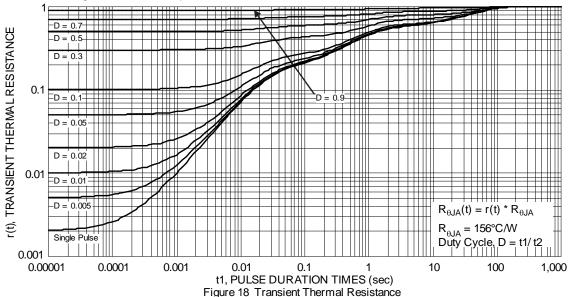


Q2 P-CHANNEL (Continued)







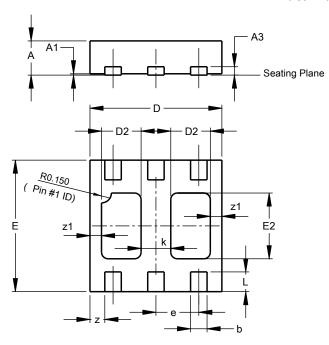




Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

U-DFN2020-6 (Type B)

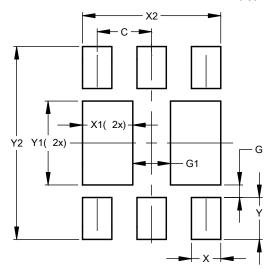


| U-DFN2020-6 | | | | | | | | |
|-------------|--------|-------------|-------|--|--|--|--|--|
| (Type B) | | | | | | | | |
| Dim | Min | Min Max Typ | | | | | | |
| Α | 0.545 | 0.605 | 0.575 | | | | | |
| A1 | 0.00 | 0.05 | 0.02 | | | | | |
| A3 | - | - | 0.13 | | | | | |
| b | 0.20 | 0.30 | 0.25 | | | | | |
| D | 1.95 | 2.075 | 2.00 | | | | | |
| D2 | 0.50 | 0.70 | 0.60 | | | | | |
| е | - | - | 0.65 | | | | | |
| Е | 1.95 | 2.075 | 2.00 | | | | | |
| E2 | 0.90 | 1.10 | 1.00 | | | | | |
| k | - | - | 0.45 | | | | | |
| L | 0.25 | 0.35 | 0.30 | | | | | |
| Z | - | - | 0.225 | | | | | |
| z1 | - | - | 0.175 | | | | | |
| All | Dimens | ions in | mm | | | | | |

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.

U-DFN2020-6 (Type B)



| Dimensions | Value |
|----------------|---------|
| Dillielisiolis | (in mm) |
| C | 0.650 |
| G | 0.150 |
| G1 | 0.450 |
| Х | 0.350 |
| X1 | 0.600 |
| X2 | 1.650 |
| Y | 0.500 |
| Y1 | 1.000 |
| Y2 | 2 300 |



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